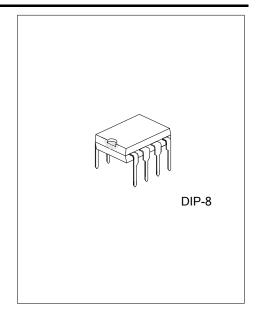
UPS1602

LINEAR INTEGRATED CIRCUIT

HIGH PERFORMANCE CURRENT MODE POWER SWITCH

DESCRIPTION

The UTC **UPS1602** is designed to provide several special enhancements to satisfy the needs, for example, power-saving mode for low standby power (<0.3w), frequency hopping, constant output power limiting, slope compensation, over current protection (OCP), over voltage protection (OVP), over load protection (OLP), under voltage lock out (UVLO), short Circuit Protection (SCP) and Over Temperature Protection (OTP), etc. IC will be shut down or can auto-restart in those situations.

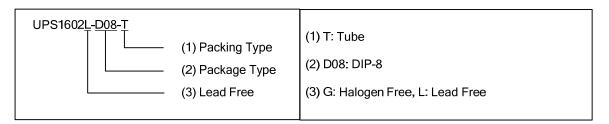


■ FEATURES

- * Low startup current (about 22µA)
- * Fixed switching frequency(Norm. is 68KHz)
- * Frequency hopping for Improved EMI Performance.
- * Lower than 0.3W Standby Power Design
- * Linearly decreasing frequency to 26KHz during light load
- * Soft start
- * Internal Slope Compensation
- * Constant Power Limiting for universal AC input Range
- * Gate Output Maximum Voltage Clamp(15V)
- * Max duty cycle 74%
- * Over temperature protection
- * Overload protection
- * Over voltage protection
- * Leading edge blanking
- * Cycle-by-Cycle current limiting
- * Under Voltage Lock Out
- * Short Circuit Protection

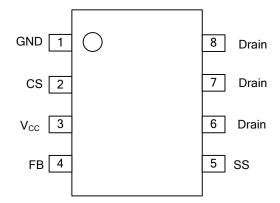
■ ORDERING INFORMATION

Ordering	Number	Package	Dooking	
Lead Free	Lead Free Halogen Free		Packing	
UPS1602L-D08-T	UPS1602G-D08-T	DIP-8	Tube	



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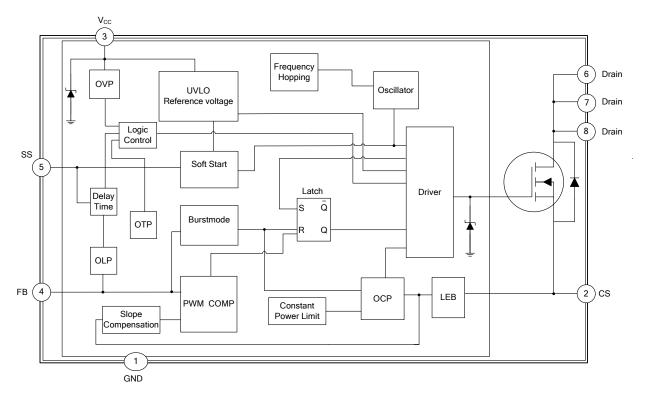
■ PIN CONFIGURATION



■ PIN DESCRIPTION

PIN NO.	SYMBOL	DESCRIPTION
1	GND	Ground
2	CS	Controller current sense input
3	V_{CC}	Supply voltage
4	FB	Feedback
5	SS	Soft-start, connect Capacitor C _{SOFTS} to GND
6, 7, 8	Drain	Power MOSFET drain

■ BLOCK DIAGRAM



Notes: OLP (Over Load Protection)

OVP (Over Voltage Protection)

OTP (Over Temperature Protection)

OCP (Over Current Protection)

UVLO (Under Voltage Latch-Out)

LEB (Led Edge Blanking)

SS (Soft Start)

■ **ABSOLUTE MAXIMUM RATINGS** (T_A=25°C, unless otherwise specified)

PARAMETER	SYMBOL	RATINGS	UNIT
Supply Voltage	V_{CC}	30	V
Input Voltage to FB Pin	V_{FB}	-0.3 ~ 6.2	V
Input Voltage to CS Pin	V _{CS}	-0.3 ~ 2.8	V
Junction Temperature	T_J	+150	°C
Operating Temperature	T_{OPR}	-40 ~ +125	°C
Storage Temperature	T _{STG}	-50 ~ + 150	°C

Note: Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

■ RECOMMENDED OPERATING CONDITIONS

PARAMETER	SYMBOL	RATINGS	UNIT	
Supply Voltage	V_{CC}	8.6 ~ 22	V	

■ ELECTRICAL CHARACTERISTICS (T_A=25°C, V_{CC}=15V, unless otherwise specified)

PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
SUPPLY SECTION								
Start Up Current		I _{STR}	$V_{CC} = V_{CC(ON)}-0.1V$		22	45	μΑ	
Committee Commont with a witch		I_{OFF}	$V_{SS} = 0$, $I_{FB} = 0$		7	9	mA	
Supply Current with switch		I _{ON}	$V_{SS} = 4.8V$, $I_{FB} = 0$		7	9	mΑ	
UNDER-VOLTAGE LOCKOUT SECTION								
Start Threshold Voltage		$V_{THD(ON)}$		13.5	14.2	15	V	
Min. Operating Voltage		$V_{CC(MIN)}$		7.5	8.2	9	V	
Hysteresis		V _{CC(HY)}			6		V	
INTERNAL VOLTAGE RE	FERENCE							
Reference Voltage		V_{REF}	measured at pin V _{FB}	6.3	6.5	6.7	V	
CONTROL SECTION								
V _{FB} Operating Level	_	V_{MIN}		0.5			V	
VFB Operating Level		V_{MAX}				4.4		
Burst-Mode Out FB Voltag	е	$V_{FB(OUT)}$	V _{CS} =0		1.7		V	
Reduce-Frequency end FE		$V_{FB(END)}$	V _{CS} =0		1.6		V	
Burst-Mode Enter FB Volta	age	$V_{FB(IN)}$	V _{CS} =0		1.5		V	
Switch Frequency	Normal	-	$V_{FB} = 4V$	61	68	75	kHz	
Switch Frequency	Power-Saving	F _(SW)	Before enter burst mode	20		40	kHz	
Duty Cycle	_	D_{MAX}	V_{FB} =4.4V, V_{CS} =0	68	74	80	%	
Duty Cycle		D _{MIN}	V _{FB} <0.5V	0			%	
Frequency Hopping		$F_{J(SW)}$		±1.5	±3	±4.5	kHz	
Frequency Variation VS V	CC Deviation	F_{DV}	V _{CC} =10 to 20V			5	%	
Frequency Variation VS To Deviation	emperature	F_{DT}	T=-40 to 105°C			5	%	
Feedback Resistor		R _{FB}	V _{FB} =0V	16	21	26	kΩ	
Soft-Start Time		T _{SS}	C _{SS} =0.47µF	9.9	11.2	12.6	ms	
PROTECTION SECTION								
OV/D threehold		V_{OVP1}	V _{SS} <3.5V,V _{FB} >5V		19		V	
OVP threshold		V_{OVP2}	V_{SS} =4.8V, V_{FB} =3V		28		V	
OLP threshold		$V_{FB(OLP)}$	V _{CS} =0, SS-PIN OPEN	4.7	4.9	5.1	V	
Delay Time Of OLP		T _{D-OLP}	C _{SS} =0.47µF	55	62	70	ms	
OTP threshold		$T_{(THR)}$		120	135	150	°C	
OVP Disable threshold		V _{SS (DEACT)}	V _{FB} >5V, V _{CC} = 22V	3.9	4.1	4.3	V	
OLP Enable threshold		V _{SS (ACT)}	V _{FB} >5V	5.1	5.4	5.7	V	

■ ELECTRICAL CHARACTERISTICS(Cont.)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
CURRENT LIMITING SECTION						
Peak Current Limitation	V_{CS}	V _{FB} =4.4V		0.86	1	V
Threshold Voltage For I _{VIN} =60µA	$V_{SENSE-L}$	I _{VIN} =60μA		0.77		V
POWER MOS-TRANSISTOR SECTION						
Drain-Source Breakdown Voltage	V_{DSS}	V_{GS} =0V, I_{D} =250 μ A	650			V
Turn-on voltage between gate and source	V_{TH}	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	2		4	V
Drain-Source Diode Continuous Source Current	Is				2	Α
Static Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =1A		3.8	5	Ω
Rise Time	t_R	$V_{DD} = 300V, I_D = 2.4A$		25	60	ns
Fall Time	t _F	$R_G = 25\Omega \text{ (Note 1,2)}$		25	60	ns

Note: 1. Pulse Test: Pulse Width≤300µs, Duty cycle≤2%

2. Essentially independent of operating temperature

■ FUNCTIONAL DESCRIPTION

The internal reference voltages and bias circuit work at V_{CC}> V_{THD (ON)}, and shutdown at V_{CC}<V_{CC(MIN)}.

(1) Soft-Start

When every IC power on, driver output duty cycle will be decided by voltage V_{SS} on soft-start capacitor and V_{CS} on current sense resistor at beginning. After V_{SS} reach 4.2V, the whole soft-start phase end, and driver duty cycle depend on V_{FB} and V_{CS} . The relation among V_{SS} , V_{FB} and V_{OUT} as followed Fig.3.

Furthermore, soft-start phase should end before V_{CC} reach $V_{CC(MIN)}$ during V_{CC} power on. Otherwise, if soft-start phase remain not end before V_{CC} reach $V_{CC(MIN)}$ during V_{CC} power on, IC will enter auto-restart phase and not set up V_{OUT} . So the value of C_{SS} should be between $0.1\mu F$ and $4.7\mu F$.

Finally soft-start also set OVP1 active phase. OVP1 active phase between 0 and $V_{SS(DEACT)}$, OVP1 will not be sensed after V_{SS} reach V_{SS} (DEACT). The Soft-start phase T_{SS} : T_{SS} = 23.8× C_{SS} (ms) (Example: C_{SS} =0.47 μ F, then T_{SS} =23.8×0.47=11.2ms).

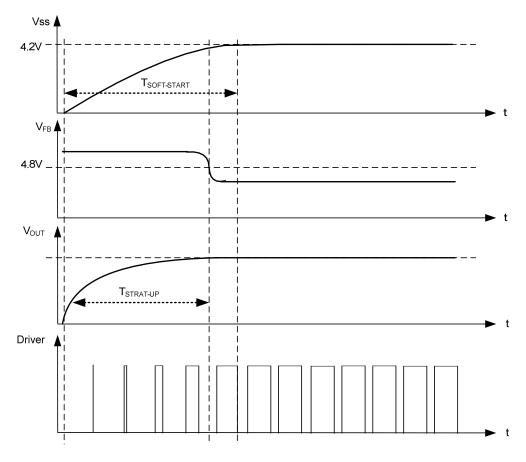


Fig.3 Soft-start phase

■ FUNCTIONAL DESCRIPTION(Cont.)

(2) Switch Frequency Set

The maximum switch frequency is set to 68kHz. Switch frequency is modulated by output power P_{OUT} during IC operating. At no load or light load condition, most of the power dissipation in a switching mode power supply is from switching loss on the MOSFET transistor, the core loss of the transformer and the loss on the subber circuit. The magnitude of power loss is in proportion to the number of switching events within a fixed period of time. So lower switch frequency at lower load, which more and more improve IC's efficiency at light load. At from no load to light load condition, the IC will operate at from Burst mode to Reducing Frequency Mode. The relation curve between f_{SW} and $P_{OUT}/P_{OUT(MAX)}$ as followed Fig.4.

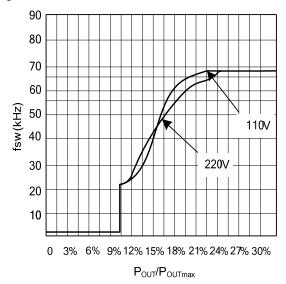


Fig.4 The relation curve between f_{SW} and relative output power P_{OUT}/ P_{OUT(MAX)}

(3) Internal Synchronized Slope Compensation

Built-in slope compensation circuit adds voltage ramp onto the current sense input voltage for PWM generation, this greatly improves the close loop stability at CCM and prevents the sub-harmonic oscillation and thus reduces the output ripple voltage.

(4) Frequency Hopping For EMI Improvement

The Frequency hopping is implemented in the IC; there are two oscillators built-in the IC. The first oscillator is to set the normal switching frequency; the switching frequency is modulated with a period signal generated by the 2nd oscillator. The relation between the first oscillator and the 2nd oscillator as followed Fig.5. So the tone energy is evenly spread out, the spread spectrum minimizes the conduction band EMI and therefore eases the system design in meeting stringent EMI requirement.

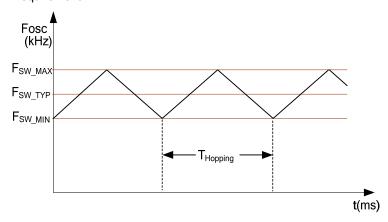


Fig.5 Frequency Hopping

■ FUNCTIONAL DESCRIPTION(Cont.)

(5) Constant Output Power Limit

When the SENSE voltage, across the sense resistor R_S , reaches the threshold voltage, around 1V, the output GATE drive will be turned off after a small propagation delay t_D . This propagation delay will introduce an additional current proportional to $t_D \times V_{IN}/L_P$. Since the propagation delay is nearly constant regardless of the input line voltage V_{IN} . Higher input line voltage will result in a larger additional current and hence the output power limit is also higher than that under low input line voltage. To guarantee the output power is a constant for universal input AC voltage, there is a dynamic peak limit circuit to compensate the system delay T_{D-OC} that the system delay brings on. $I_{PEAK-MAX}=0.8V/R_{SENSE}(V_{IN}=264VAC)$, $I_{PEAK-MAX}=1V/R_{SENSE}(V_{IN}=85V_{AC})$. This proprietary compensation ensures a constant output power limit for wide AC input voltage from 90VAC to 264VAC.

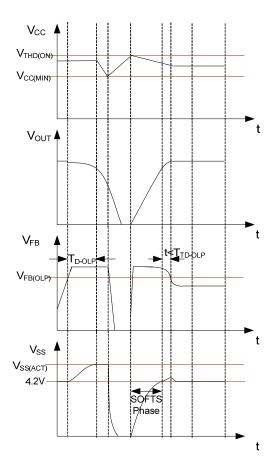
(6) Protection section

The IC takes on more protection functions such as OLP, OVP and OTP etc. In case of those failure modes for continual blanking time, the driver is shut down. At the same time, IC enters auto-restart, V_{CC} power on and driver is reset after V_{CC} power on again.

OLP

After soft-start phase end, IC will shutdown driver if over load state occurs for continual $T_{D\text{-}OLP}$. OLP function will not inactive during soft-start phase. OLP case as followed Fig. 6. The test circuit as followed Fig. 8. $T_{D\text{-}OLP}$ =5.53× T_{SS} . **OVP**

There are two kinds of OVP circuits, the first OVP function are enabled only when $V_{SS} < V_{SS\,(DEACT)} \& V_{FB} > V_{FB} > V_{FB} > V_{COLP}$ during soft-start phase. During above condition, driver will be shutdown if over voltage state occurs ($V_{CC} > V_{OVP1}$) for continual a blanking time. The first OVP function will not inactive after soft-start phase. The second OVP will shutdown the switching of the power MOSFET whenever $V_{CC} > V_{OVP2}$. The first OVP case as followed Fig. 7. The test circuit as followed Fig. 9.



V_{CC}(MIN)
V_{THD(ON)}
V_{THD(ON)}
V_{CC(MIN)}
V_{FB}
Blanking
V_{FB}
V_{SS}
V_{SS(ACT)}
V_{SS(DEACT)}
V_{SS(DEACT)}
OVP Phase
t

Fig.6 OLP case

Fig.7 OVP case

■ FUNCTIONAL DESCRIPTION(Cont.)

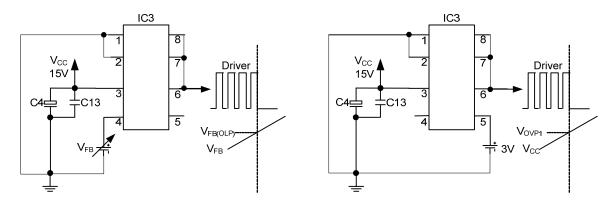


Fig.8 OLP test circuit

Fig.9 OVP test circuit

OTP

OTP will shut down driver when junction temperature T_J>T_(THR) for continual a blanking time.

(7) Driver Output Section

The driver-stage drives the gate of the MOSFET and is optimized to minimize EMI and to provide high circuit efficiency. This is done by reducing the switch on slope when reaching the MOSFET threshold. This is achieved by a slope control of the rising edge at the driver's output. The output driver is clamped by an internal 15V Zener diode in order to protect power MOSFET transistors against undesirable gate over voltage.

(8) Inside power switch MOS transistor

Specific power MOS transistor parameter is as "POWER MOS TRANSISTOR SECTION" in electrical characteristics table.

■ TYPICAL APPLICATION CIRCUIT

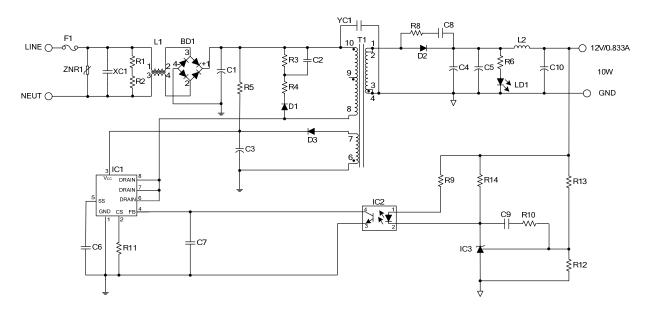
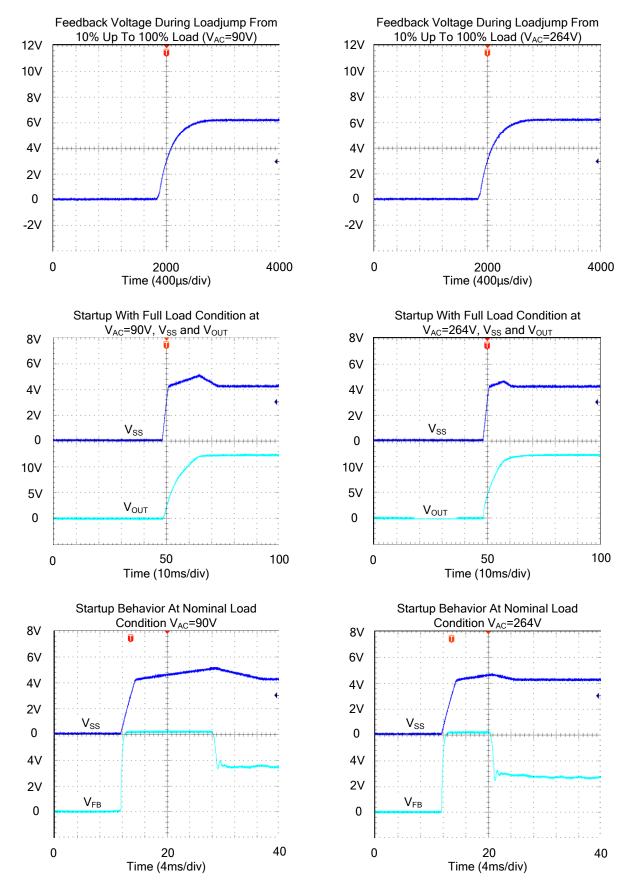


Fig.10 UTC UPS1602 Typical Application Circuit

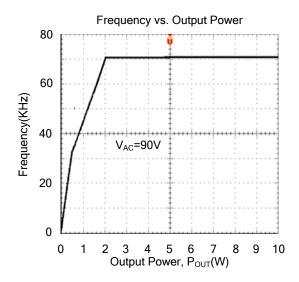
Table1. Components reference description for UPS1602 application circuit

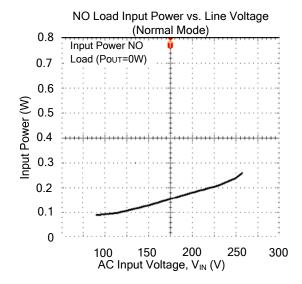
DESIGNATOR	PART TYPE	DESIGNATOR	PART TYPE	DESIGNATOR	PART TYPE
C1	22µF	R4	100	D3	RS1D
C2	0.001µF	R5	1ΜΩ	IC1	UPS1602
C3	22µF	R6	10K	IC2	PC-817
C4	330µF	R8	15Ω	IC3	TL431
C5	330µF	R9	560Ω	YC1	222
C6	0.1µF	R10	1ΚΩ	T1	EE22
C7	0.01µF	R11	1.5Ω	L1	UU9.8
C8	0.001µF	R12	3.9ΚΩ	L2	2uH
C9	0.1µF	R13	15ΚΩ	LD1	LED
C10	220µF	R14	1.8ΚΩ	F1	1A/250V
R1	2.2ΜΩ	D1	FR107	ZNR1	7D471K
R2	2.2ΜΩ	D2	SB3100	BD1	DI106
R3	68ΚΩ			XC1	154

■ TYPICAL CHARACTERISTICS



■ TYPICAL CHARACTERISTICS(Cont.)





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